



BUX66

NPN Silicon Low Frequency High Power



Switching Transistor

Features:

1. Heavy working current.Good temperature stability.Excellent thermal fatigue capability.
2. Good Switching Characteristic.
3. Implementation of standards: GJB33 A-97, QZJ840611A, QZJ840611
4. Use for Low-speed switch,low frequency power amplify,power adjustment.
5. Quality Class: JP, JT, JCT, GS, G, G+

TECHNICAL DATA:

($T_a = 25^\circ\text{C}$)

Parameter name	Symbols	Unit	Specifications	Test Condition
Total Dissipation	P_{tot}	W	35	$T_c=25^\circ\text{C}$
Max. Collector Current	I_{CM}	A	2	
Junction Temperature	T_{jm}	$^\circ\text{C}$	175	
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	V	200	$I_c=1\text{mA}$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	V	150	$I_c=1\text{mA}$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	V	6	$I_E=1\text{mA}$
Collector- Emitter Saturation Voltage Drop	$V_{CE(sat)}$	V	2.5	$I_c=1\text{A}, I_B=0.15\text{A}$
Collector-Base Laekage Current	I_{CBO}	μA	10	$V_{CB}=200\text{V}$
Collector-Emitter Laekage Current	I_{CEO}	μA	100	$V_{CE}=100\text{V}$
Emitter-Base Leakage Current	I_{EBO}	mA	1	$V_{EB}=6\text{V}$
DC Current Gain	h_{FE}		10~60	$V_{CE}= 5\text{V}, I_c=1\text{A}$
Delay Time	t_d	μs	-	$V_{CE}= 20\text{V}, I_c=1\text{A}, I_{B1}=0.1\text{A}, I_{B2}=-0.1\text{A}$
Rise Time	t_r	μs	0.6	
Storage Time	t_s	μs	2.5	
Fall Time	t_f	μs	0.6	

Outline and Dimensions: